SIM Card Connector

multicomp



Specification

2.9

2.8

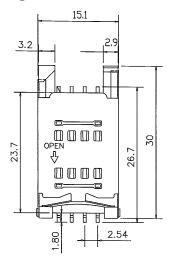
30.8

C

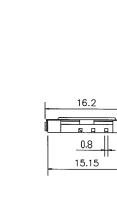
0.10

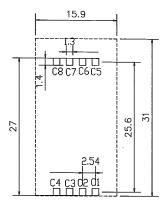
Voltage Current Rating	: 1 Amp 50V AC
Insulation Resistance	: 1000MΩ min.
Contact Withstanding Voltage	: AC 500V for 1 minute
Temperature Rating	: -40°C to +85°C
Housing	: LCP
Contact	: Selective Gold Flash

Diagram



Dimensions : Millimetres





PCB LAYOUT RECOMMENDED

Part Number Table

Description	Part Number
SIM Card CONN., 8P, SMT, Hinge Type	MC002013

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